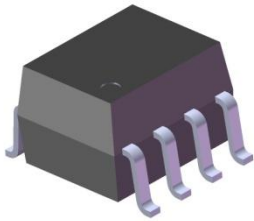


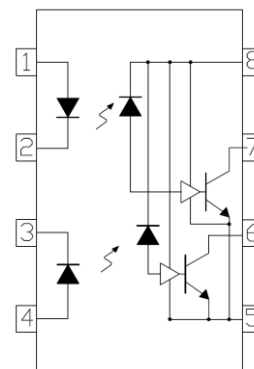
8 PIN SOP DUAL CHANNEL HIGH SPEED 10MBit/s LOGIC GATE PHOTOCOUPLER EL063X Series



Features

- Compliance Halogen Free .
(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)
- High speed 10Mbit/s
- 10kV/μs min. common mode transient immunity (EL0631)
- Guaranteed performance from -40 to 85°C
- Wide operating temperature range of -40°C to 100°C
- Logic gate output
- High isolation voltage between input and output (Viso=3750 V rms)
- Compliance with EU REACH
- Pb free and RoHS compliant
- UL and cUL approved(No. E214129)
- VDE approved (No.40028116)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

Schematic



Pin Configuration

1. Anode
2. Cathode
3. Cathode
4. Anode
5. Gnd
6. Vout 2
7. Vout 1
8. VCC

Description

The EL0630 and EL0631 are dual channel devices each consists of an infrared emitting diode optically coupled to a high speed integrated photo detector logic gate with a strobable output.

The devices are packaged in an 8-pin small outline package which conforms to the standard SO8 footprint.

Applications

- Ground loop elimination
- LSTTL to TTL, LSTTL or 5 volt CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supplies
- Pulse transformer replacement
- Computer peripheral interface

Truth Table (Positive Logic)

Input	Output
H	L
L	H

Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	DC/ Average Forward current	I_F	20	mA
	Reverse voltage	V_R	5	V
	Power dissipation	P_D	45	mW
Output	Power dissipation	P_C	60	mW
	Output current	I_O	50	mA
	Output voltage	V_O	7.0	V
	Supply voltage (max 1 minute)	V_{CC}	7.0	V
	Output Power Dissipation	P_O	80	mW
	Isolation voltage ^{*1}	V_{ISO}	3750	V rms
	Operating temperature	T_{OPR}	-40 ~ +100	°C
	Storage temperature	T_{STG}	-55 ~ +125	°C
	Soldering temperature ^{*2}	T_{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2, 3, 4 are shorted together, and pins 5, 6, 7, 8 are shorted together.

*2 For 10 seconds

Electrical Characteristics (Ta=-40 to 85°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	V_F	-	1.4	1.8	V	$I_F=10\text{mA}$
Reverse voltage	V_R	5.0	-	-	V	$I_R=10\mu\text{A}$
Temperature coefficient of forward voltage	$\Delta V_F/\Delta T_A$	-	-1.8	-	mV/°C	$I_F=10\text{mA}$
Input capacitance	C_{IN}	-	60	-	pF	$V_F=0, f=1\text{MHz}$

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
High level supply current	I_{CCH}	-	13	18	mA	$I_F=0\text{mA}, V_{CC}=5.5\text{V}$
Low level supply current	I_{CCL}	-	15	21	mA	$I_F=10\text{mA}, V_{CC}=5.5\text{V}$

Transfer Characteristics (Ta=-40 to 85°C unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
HIGH Level Output Current	I_{OH}	-	-	100	μA	$V_{CC}=5.5\text{V}, V_O=5.5\text{V}, I_F=250\mu\text{A},$
LOW Level Output Current	V_{OL}	-	-	0.6	V	$V_{CC}=5.5\text{V}, I_F=5\text{mA}, I_{CL}=13\text{mA}$
Input Threshold Current	I_{FT}	-	-	5	mA	$V_{CC}=5.5\text{V}, V_O=0.6\text{V}, I_{OL}=13\text{mA}$

Switching Characteristics ($T_a=-40$ to 85°C , $V_{CC}=5\text{V}$, $I_F=7.5\text{mA}$ unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Propagation delay time to output High level* ⁴ (Fig.11)	t_{PHL}	-	-	100	ns	$C_L=15\text{pF}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$
Propagation delay time to output Low level* ⁵ (Fig.11)	t_{PLH}	-	-	100	ns	$C_L=15\text{pF}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$
Pulse width distortion	$ \frac{t_{PHL} - t_{PLH}}{t_{PLH}} $	-	-	35	ns	$C_L=15\text{pF}$, $R_L=350\Omega$
Output rise time* ⁶ (Fig.11)	t_r	-	40	-	ns	$C_L=15\text{pF}$, $R_L=350\Omega$
Output fall time* ⁷ (Fig.11)	t_f	-	10	-	ns	$C_L=15\text{pF}$, $R_L=350\Omega$
Common Mode Transient Immunity at Logic High* ⁸	EL0630 ICM _{HI}	5000	-	-	V/ μs	$I_F=0\text{mA}$, $V_{OH(MIN)}=2.0\text{V}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$ $ V_{CM} =1\text{KV}$ (Fig.12)
Common Mode Transient Immunity at Logic Low* ⁹	EL0631 ICM _{LI}	10000	-	-	V/ μs	$I_F=0\text{mA}$, $V_{OH(MIN)}=2.0\text{V}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$ $ V_{CM} =1\text{KV}$ (Fig.12)
Common Mode Transient Immunity at Logic High* ⁸	EL0630 ICM _{HI}	5000	-	-	V/ μs	$I_F=7.5\text{mA}$, $V_{OL(MAX)}=0.8\text{V}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$ $ V_{CM} =1\text{KV}$ (Fig.12)
Common Mode Transient Immunity at Logic Low* ⁹	EL0631 ICM _{LI}	10000	-	-	V/ μs	$I_F=7.5\text{mA}$, $V_{OL(MAX)}=0.8\text{V}$, $R_L=350\Omega$, $T_A=25^{\circ}\text{C}$ $ V_{CM} =1\text{KV}$ (Fig.12)

Typical Electro-Optical Characteristics Curves

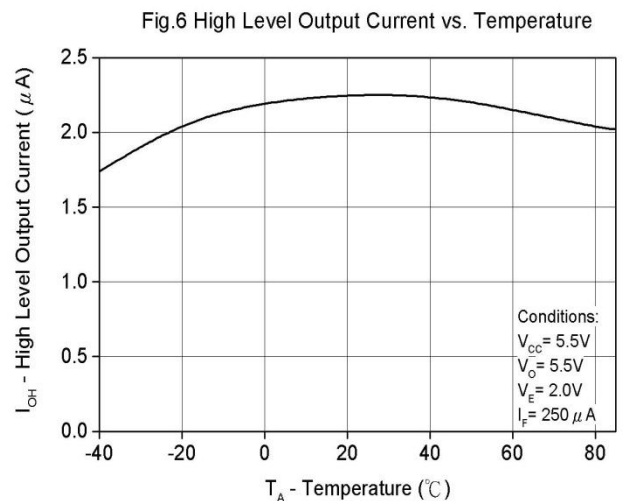
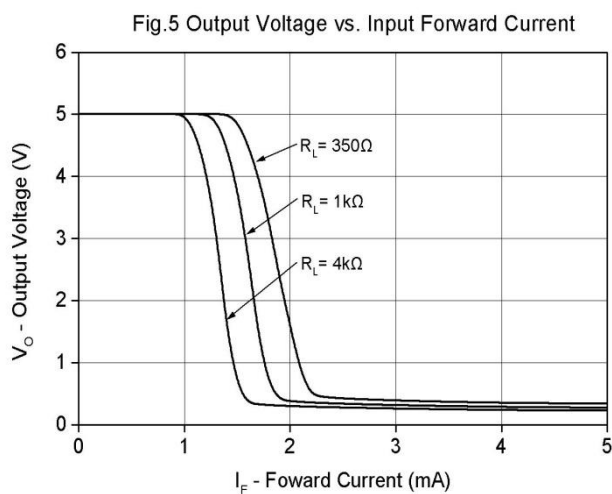
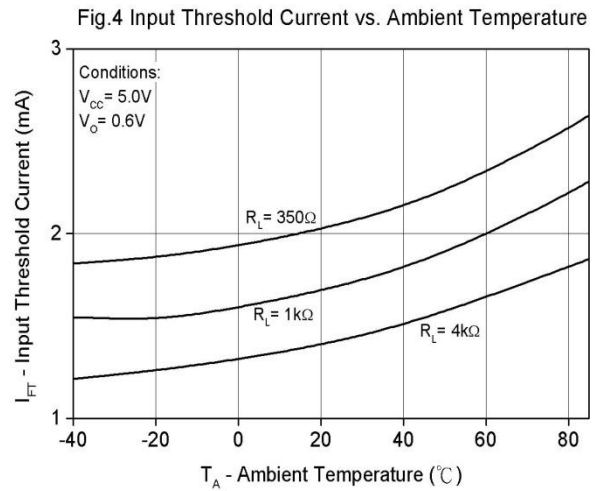
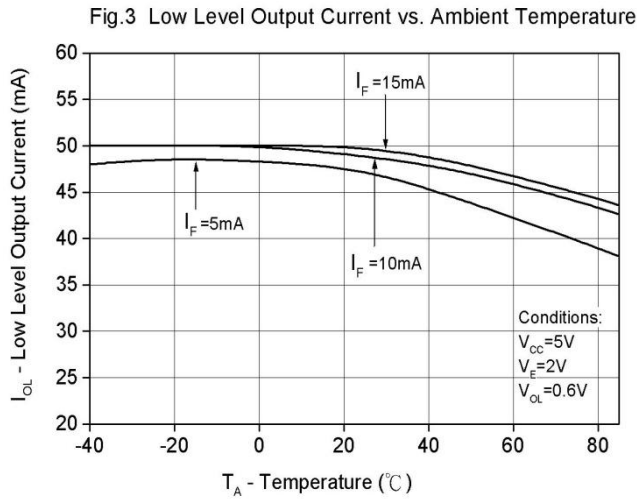
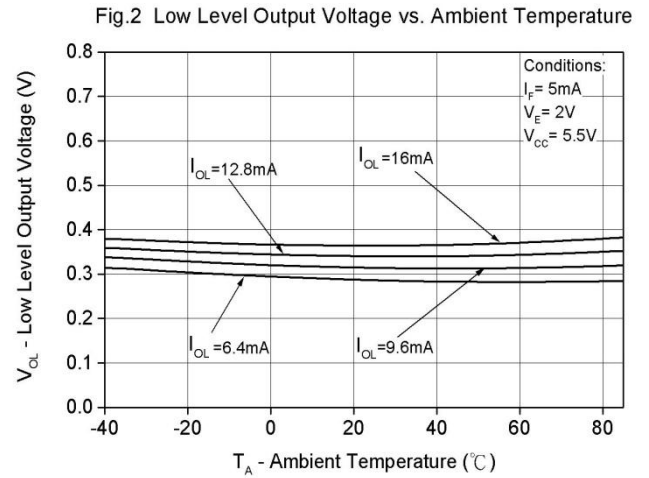
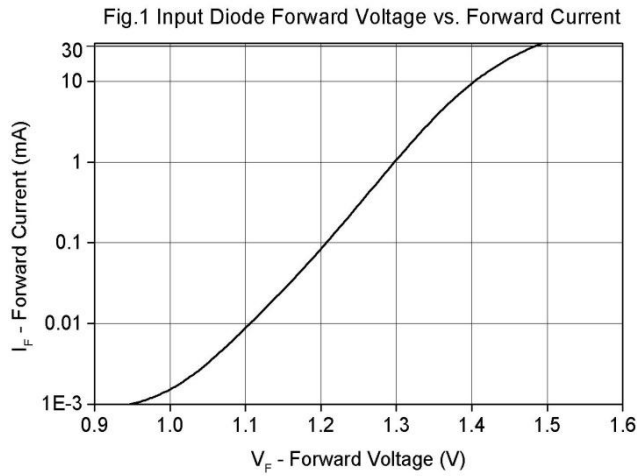


Fig.7 Switching Time vs. Forward Current

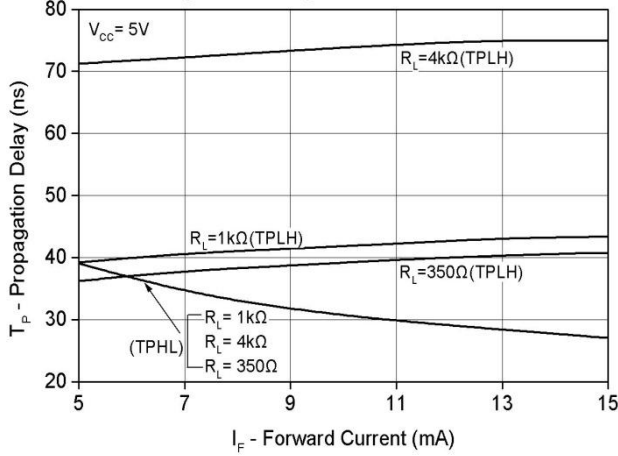


Fig.8 Switching Time vs. Temperature

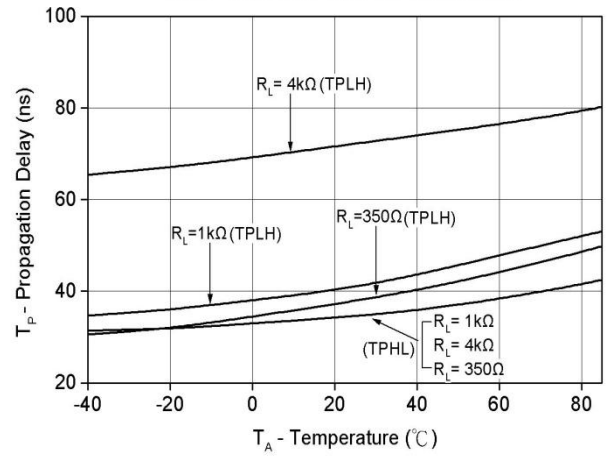


Fig.9 Pulse Width Distortion vs. Temperature

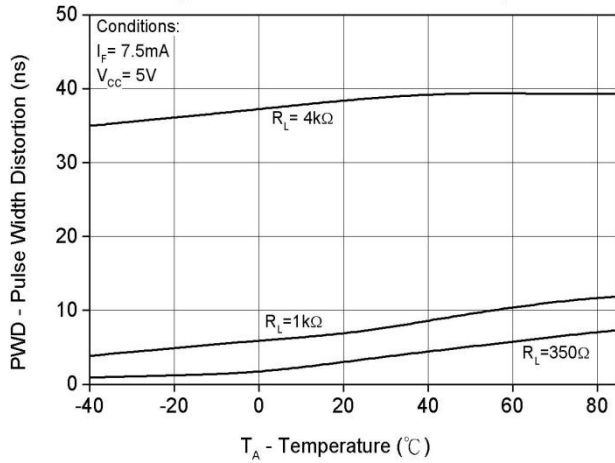


Fig.10 Rise and Fall Time vs. Temperature

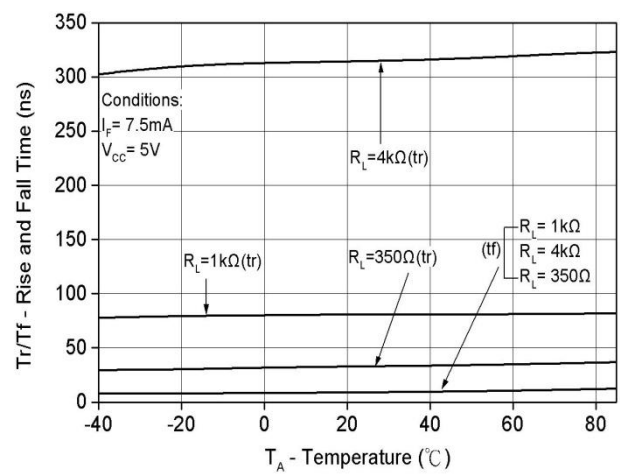


Fig. 11 Test circuit and waveforms for t_{PHL} , t_{PLH} , t_r , and t_f

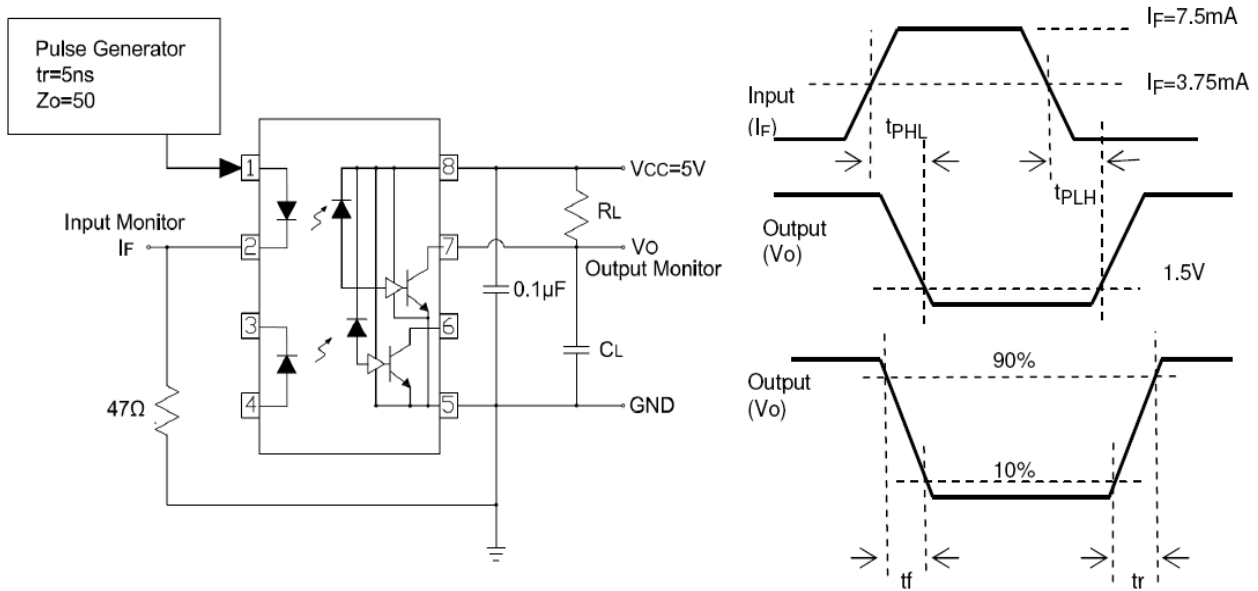
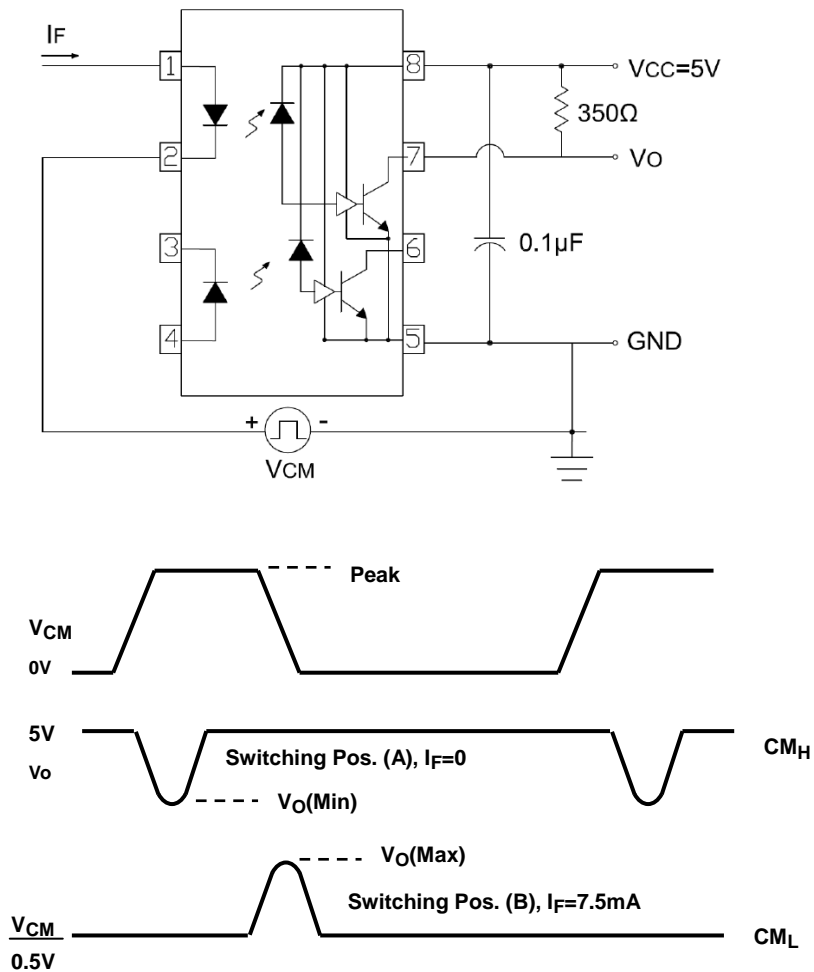


Fig. 12 Test circuit Common mode Transient Immunity



Notes

- *3 The V_{CC} supply must be bypassed by a 0.1 μ F capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package V_{CC} and GND pins
- *4. t_{PLH} – Propagation delay is measured from the 3.75mA level on the HIGH to LOW transition of the input current pulse to the 1.5 V level on the LOW to HIGH transition of the output voltage pulse.
- *5. t_{PHL} – Propagation delay is measured from the 3.75mA level on the LOW to HIGH transition of the input current pulse to the 1.5 V level on the HIGH to LOW transition of the output voltage pulse.
- *6. t_r – Rise time is measured from the 90% to the 10% levels on the LOW to HIGH transition of the output pulse.
- *7. t_f – Fall time is measured from the 10% to the 90% levels on the HIGH to LOW transition of the output pulse.
- *8 CM_H – The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the HIGH state (i.e., $V_{OUT} > 2.0V$).
- *9 CM_L – The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the LOW output state (i.e., $V_{OUT} < 0.8V$).

Order Information

Part Number

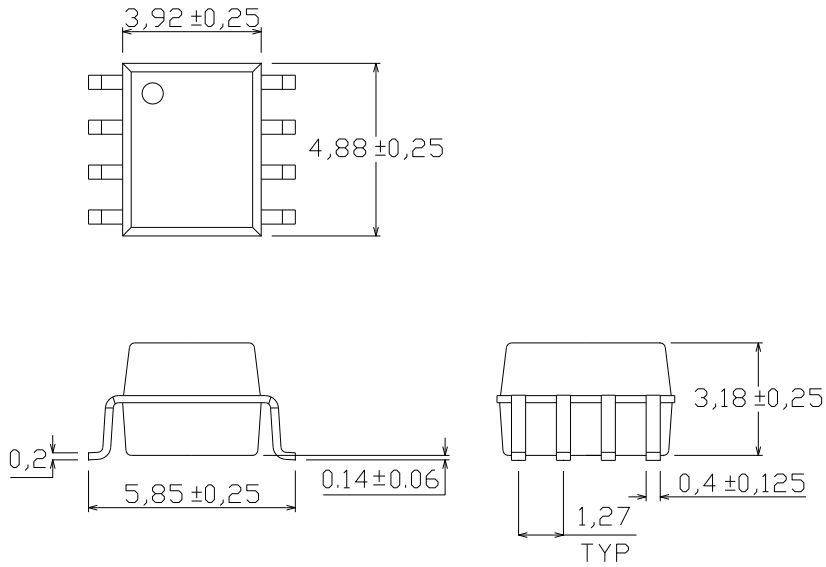
EL063X(Z)-V

Note

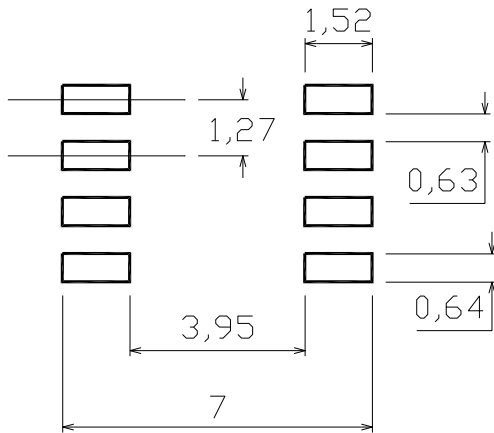
- X = Part no. (X = 0 or 1)
- Z = Tape and reel option (TA, TB or none).
- V = VDE (optional)

Option	Description	Packing quantity
None	Standard	100 units per tube
-V	Standard + VDE	100 units per tube
(TA)	TA tape & reel option	2000 units per reel
(TB)	TB tape & reel option	2000 units per reel
(TA)-V	TA tape & reel option + VDE	2000 units per reel
(TB)-V	TB tape & reel option + VDE	2000 units per reel

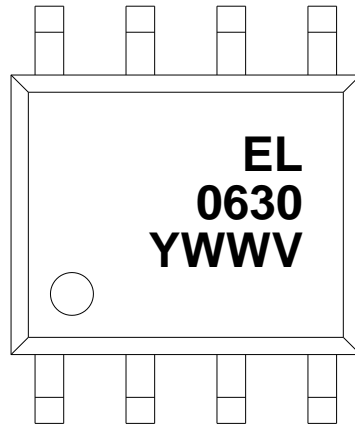
Package Dimension
(Dimensions in mm)



Recommended pad layout for surface mount leadform



Device Marking

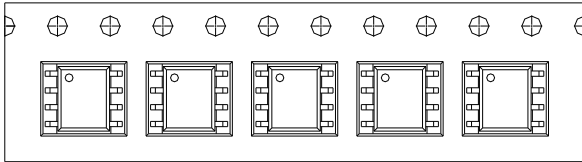


Notes

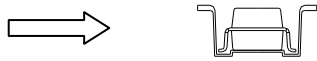
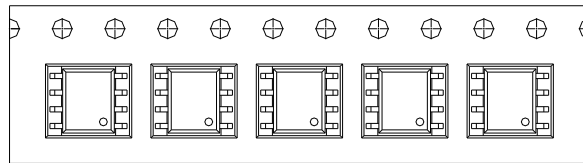
0630	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

Tape & Reel Packing Specifications

Option TA



Option TB

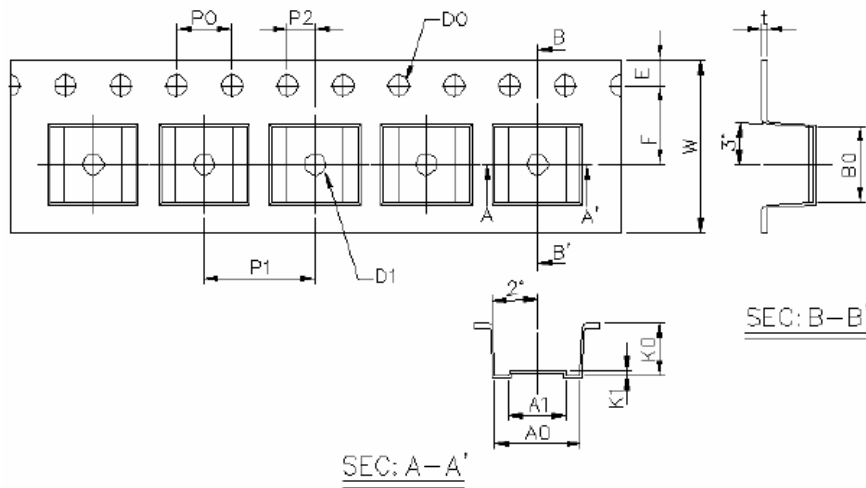


Direction of feed from reel



Direction of feed from reel

Tape dimensions

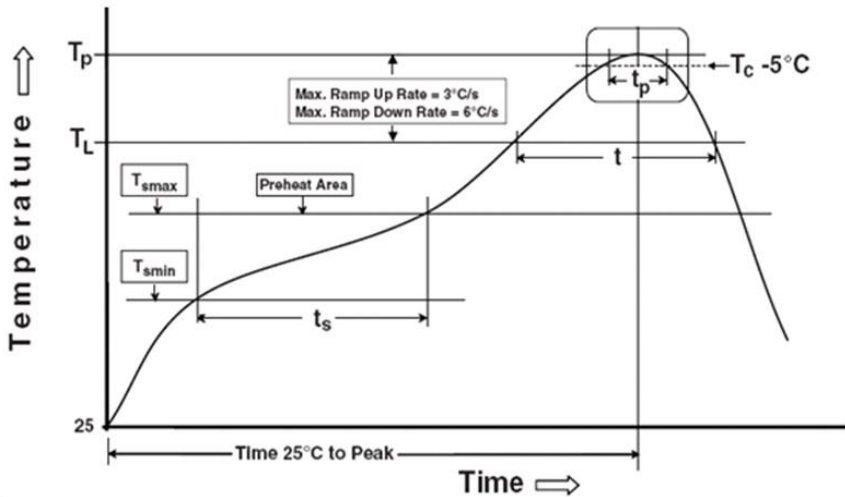


Dimension No.	A0	A1	B0	D0	D1	E	F
Dimension(mm)	6.2±0.1	4.1±0.1	5.28±0.1	1.5±0.1	1.5±0.3	1.75±0.1	5.5±0.1
Dimension No.	Po	P1	P2	t	W	K0	K1
Dimension(mm)	4.0±0.1	8.0±0.1	2.0±0.1	0.4±0.1	12.0+0.3/ -0.1	3.7±0.1	0.3±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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